



SPN9926A

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN9926A is the Dual N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

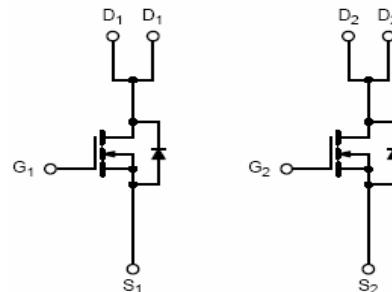
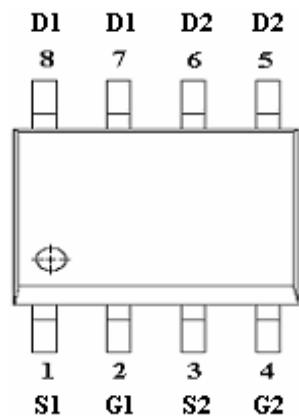
FEATURES

- ◆ 20V/6.0A,R_{DS(ON)}=30mΩ@V_{GS}=4.5V
- ◆ 20V/5.0A,R_{DS(ON)}=42mΩ@V_{GS}=2.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOP – 8P package design

APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOP – 8P)



PART MARKING



A : Lot Code
B : Date Code



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PIN DESCRIPTION

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	S2	Source 2
4	G2	Gate 2
5	D2	Drain 2
6	D2	Drain 2
7	D1	Drain 1
8	D1	Drain 1

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN9926AS8RG	SOP- 8P	SPN9926A
SPN9926AS8TG	SOP- 8P	SPN9926A

※ SPN9926AS8RG : 13" Tape Reel ; Pb – Free

※ SPN9926AS8TG : Tube ; Pb – Free

ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	20	V
Gate –Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150°C)	T _A =25°C	5.0	A
	T _A =70°C	3.4	
Pulsed Drain Current	I _{DM}	30	A
Continuous Source Current(Diode Conduction)	I _S	1.6	A
Power Dissipation	T _A =25°C	2.8	W
	T _A =70°C	1.8	
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	105	°C/W



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ELECTRICAL CHARACTERISTICS

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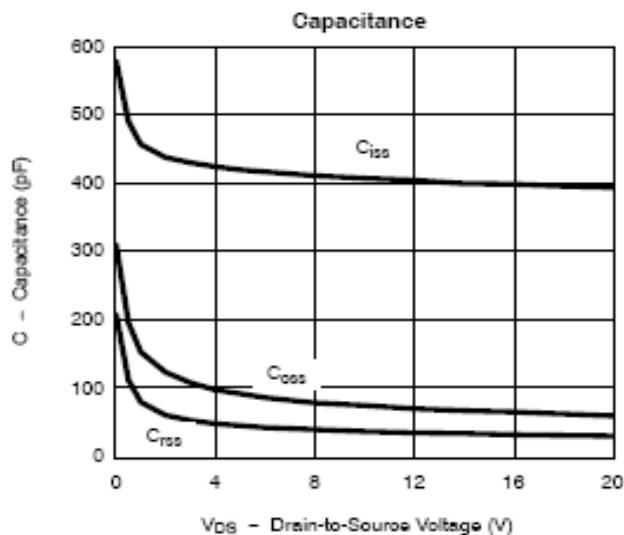
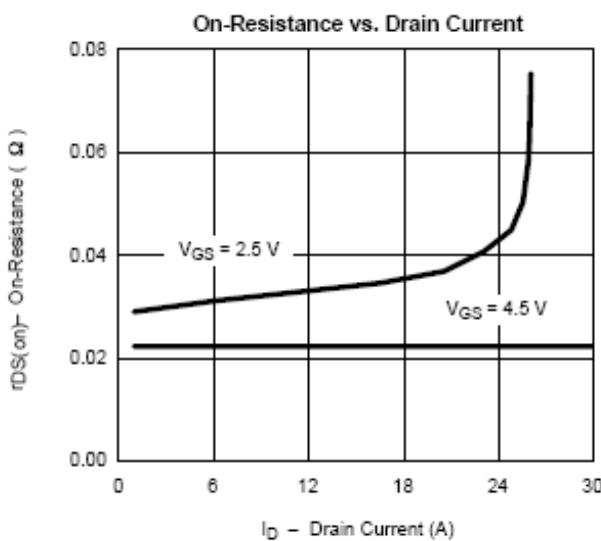
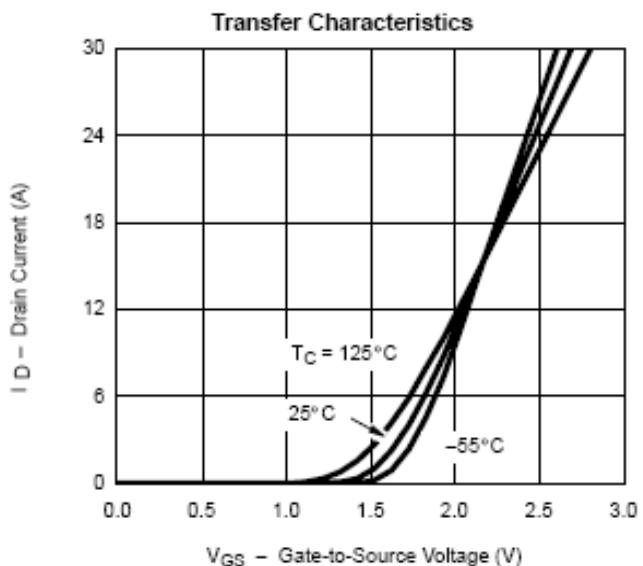
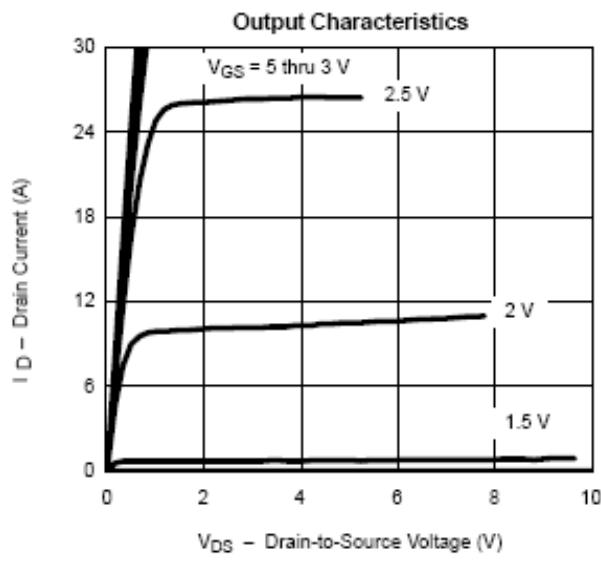
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=250uA	20			V
Gate Threshold Voltage	VGS(th)	VDS=VGS, ID=250uA	0.6			
Gate Leakage Current	IGSS	VDS=0V, VGS=±12V			±100	nA
Zero Gate Voltage Drain Current	IDSS	VDS=20V, VGS=0V			1	uA
		VDS=20V, VGS=0V TJ=55°C			5	
On-State Drain Current	ID(on)	VDS≤5V, VGS=4.5V	6			A
Drain-Source On-Resistance	RDS(on)	VGS=4.5V, ID=6.0A		0.024	0.030	Ω
		VGS=2.5V, ID=5.0A		0.032	0.042	
Forward Transconductance	gfs	VDS=5V, ID=-3.6A		10		S
Diode Forward Voltage	VSD	IS=1.7A, VGS=0V		0.8	1.2	V
Dynamic						
Total Gate Charge	Qg	VDS=10V, VGS=4.5V, ID=6.0A		2		nC
Gate-Source Charge	Qgs			2.5		
Gate-Drain Charge	Qgd			2.1		
Input Capacitance	Ciss	VDS=8V, VGS=0V f=1MHz		575		pF
Output Capacitance	Coss			84		
Reverse Transfer Capacitance	Crss			22		
Turn-On Time	td(on)	VDD=10V, RL=6Ω ID=1.0A, VGEN=4.5V RG=6Ω		10	14	ns
	tr			16	20	
Turn-Off Time	td(off)			35	40	
	tf			3	10	



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TYPICAL CHARACTERISTICS

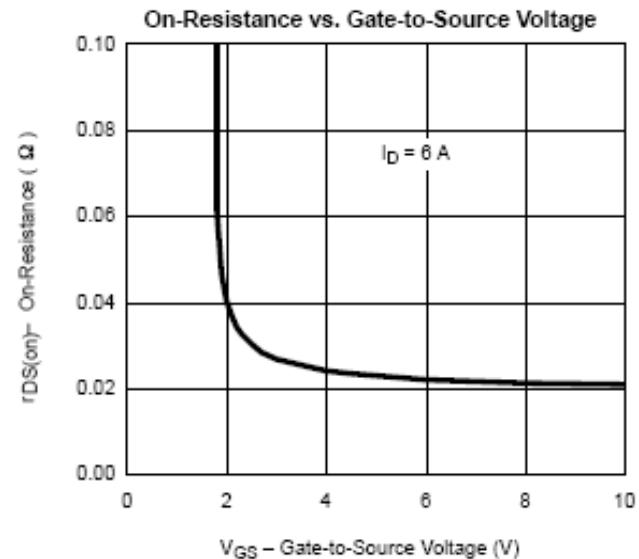
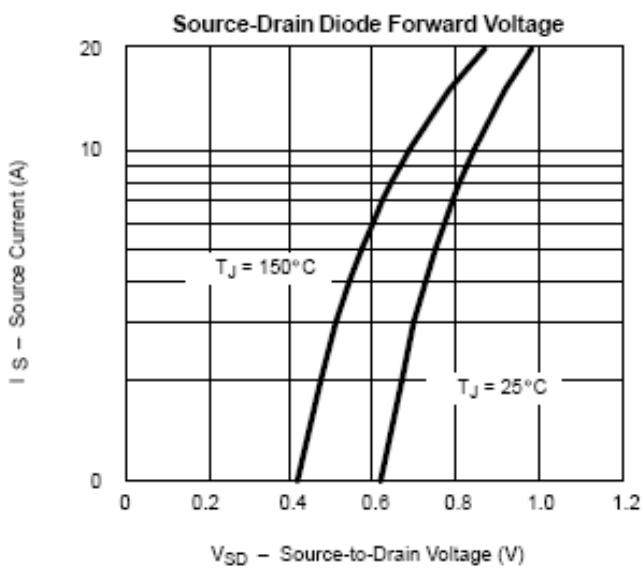
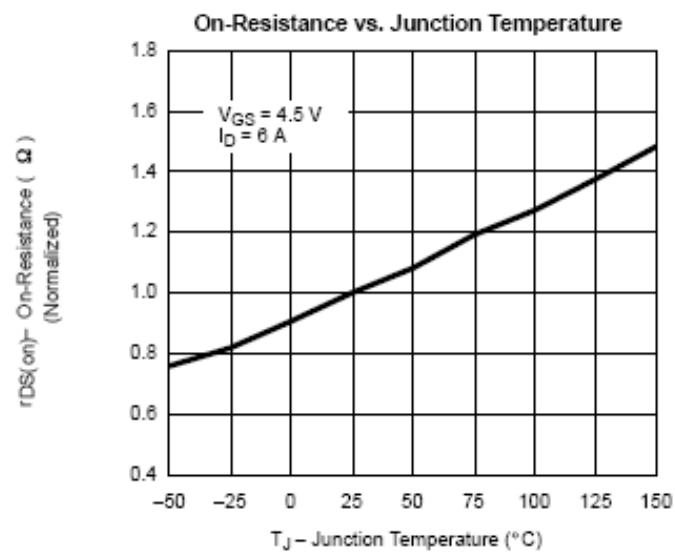
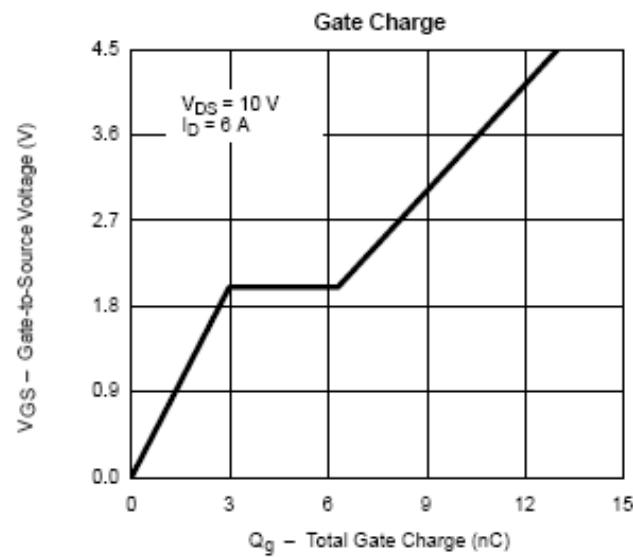




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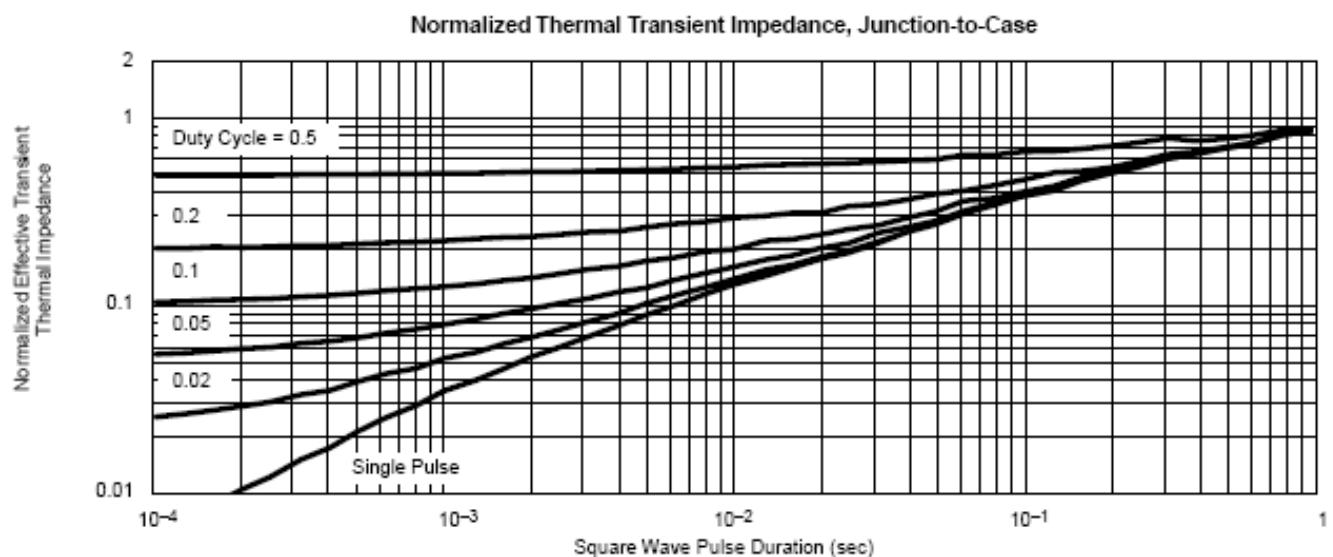
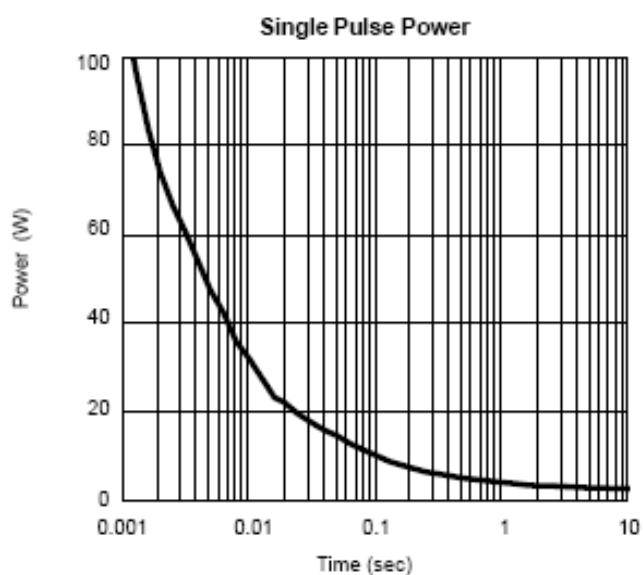
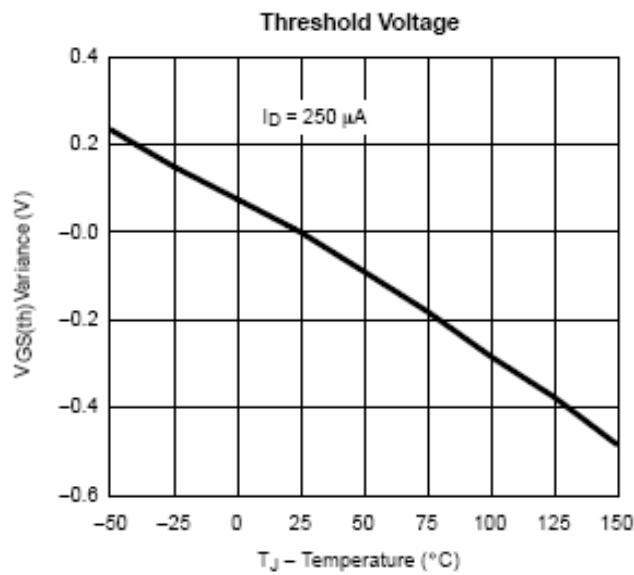




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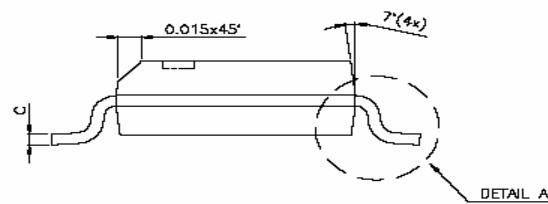
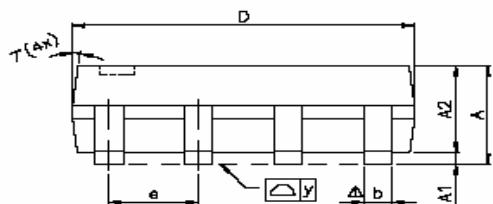
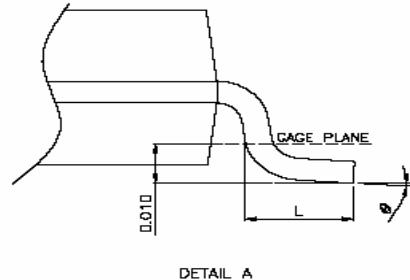
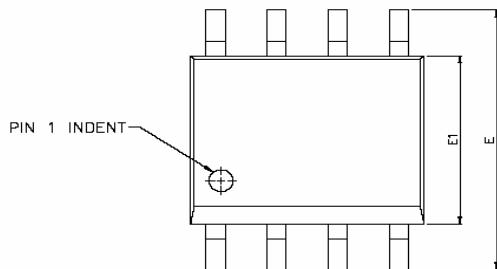




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SOP- 8 PACKAGE OUTLINE



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10	—	0.25	0.004	—	0.010
A2	—	1.45	—	—	0.057	—
b	0.33	0.41	0.51	0.013	0.016	0.020
C	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	—	1.27	—	—	0.050	—
L	0.38	0.71	1.27	0.015	0.028	0.050
$\triangle y$	—	—	0.076	—	—	0.003
θ	0°	—	8°	0°	—	8°



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